	1		2		1	3		1	4		1	5	1		;	
	Product Name: ZX137-19MIT Samtec Breakout Adapter, test board													)		4
F	Product Description: 19x2, totaling 38 pins Samtec breakout adapter supporting Samtec's HI-SPEED MIT Q-Strip Mixed Technology header. The ZX137-19MIT mates with host MIS- 019 Samtec connector. Ideal debugging development and signal measurements solution.														ſ	
-	Fully compatible with : 1- Single Ended or Differential Pair signaling MIS connectors. 2- Any connector Stack heights															-02
E	Designed in 4 layer PCBoard - No via on any signal traces - Improved signal integrity and crosstalk. - Matching connector's 50Ω impedance														JZ	2
_	Ground , <b>GND</b> , test point – The GND test point is connected to 2 inner layers ground planes as well as the MIT integral ground metal blade, plane.															
D	Application: Brin	gup, testing,	emulation	ı, develop	ment, em	bedded m	odular de	esign eval	uations							
		ntec MIS-019 es with both						air(-DP)	Signaling	type con	nectors.				0.75" (19mm)	
	<b>Pitch:</b> 0.63	8mm (0.025")	High Spe	eed conne	ector											
с	Headers: 0.1"	(2.54mm) ce	enter, 0.02	25" (0.64m	וm) SQ w	ith 0.23" ({	5.6mm) p	ost heigh	t							•
	ZX137-19MIT 038 pin configuration															
	TOP BOTTOM MIT	J1														
	Layer	10	4	8	12	16	20	24	28	32	36	GND	1			
	Bottom Headers	J3	2	6	10	14	18	22	26	30	34	38	1			
В	Top Headers	J2	3	7	11	15	19	23	27	31	35	GND	)			
		umbers refer to	1 the MIT SA	5 MTEC conr	9 nector pin nu	13 umber	17	21	25	29	33	37				
-																Z S. W
A	Notice															SI A R
	ALL ZEBAX TECHNOLOGIES DESIGN S IMPLIED, STATUTORY, OR OTHERWISI												),			D
	Information furnished is believed to be acc Specifications mentioned in this publicatio											ay result from its use	<b>.</b>			CF
	1		2		I	3		l	4		l	5	I		;	<u> </u>

